



Nintendo Switch Headphone Jack and Game Card Board Replacement

A free guide on how to replace the 3.5mm headphone jack and game card reader board in a Nintendo Switch gaming console.

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INTRODUCTION

This is an archived guide. The updated version can be found [here](#).

TOOLS:

- JIS #000 Screwdriver (1)
- ESD Safe Tweezers Blunt Nose (1)
- JIS #0 Screwdriver (1)
- Tri-point Y00 Screwdriver (1)
- Spudger (1)
- Phillips #000 Screwdriver (1)

PARTS:

- Nintendo Switch Headphone Jack and Game Card Reader Board (1)

Step 1 — Rear Panel



- Remove the four 6.3 mm Tri-point Y00 screws from the rear panel.

Step 2



- Remove the single 6.1 mm Phillips #000 screw from underneath the kickstand.

Step 3



- Remove the two 2.7 mm Phillips #000 screws from the bottom of the device.

Step 4



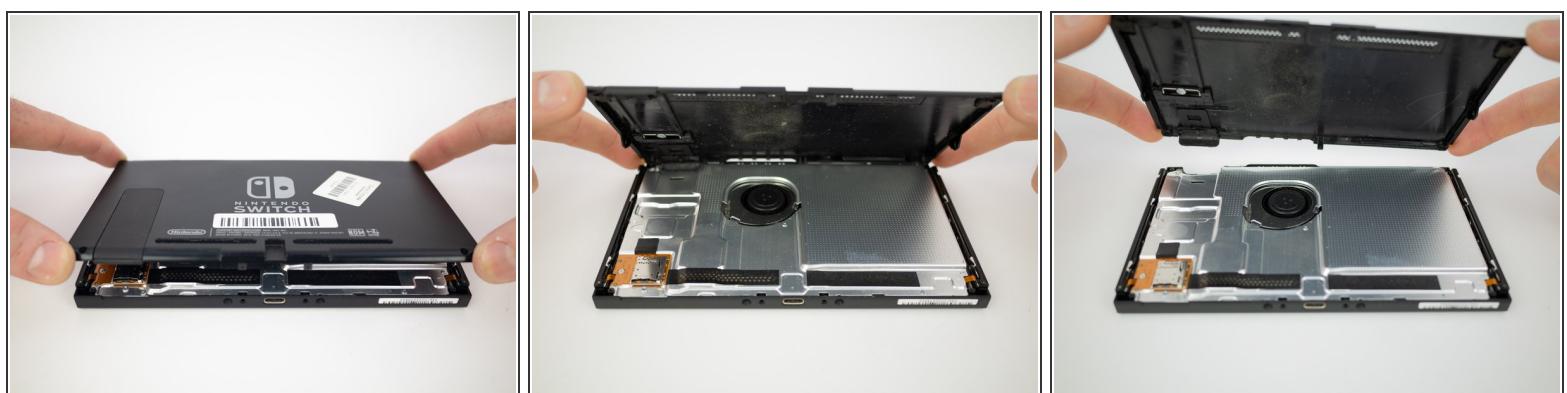
- Remove the single 2.7 mm Phillips #000 screw from the top of the device.

Step 5



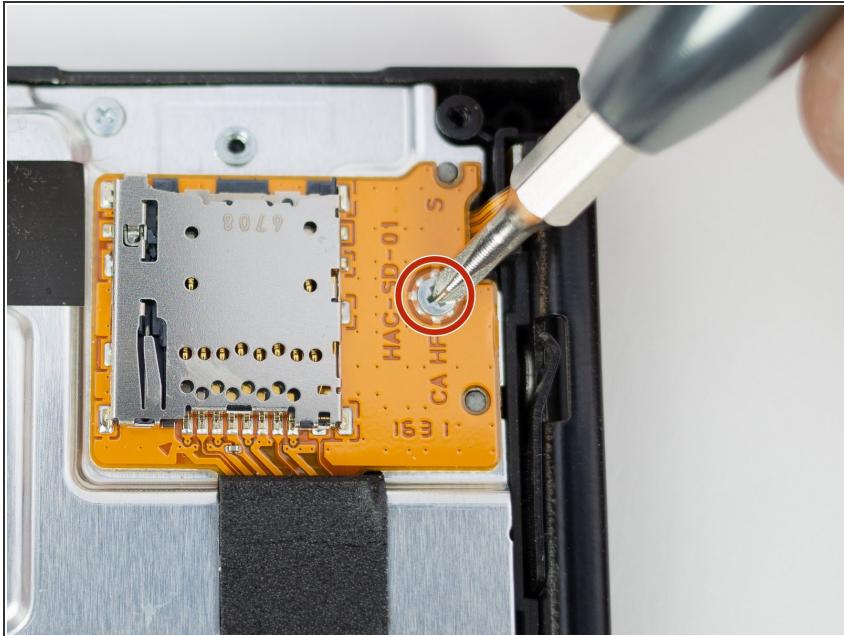
- Remove the single 3.8 mm Phillips #000 screw from the right Joy-Con rail.
- Remove the single 3.8 mm Phillips #000 screw from the left Joy-Con rail.

Step 6



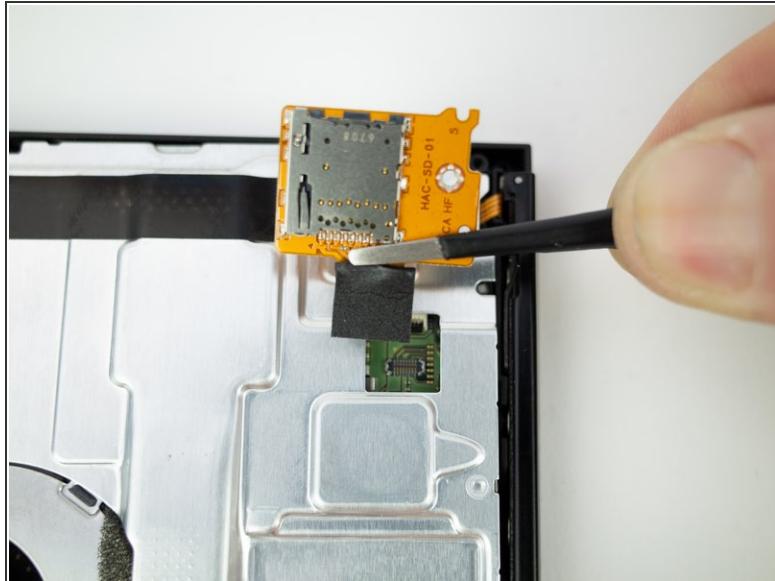
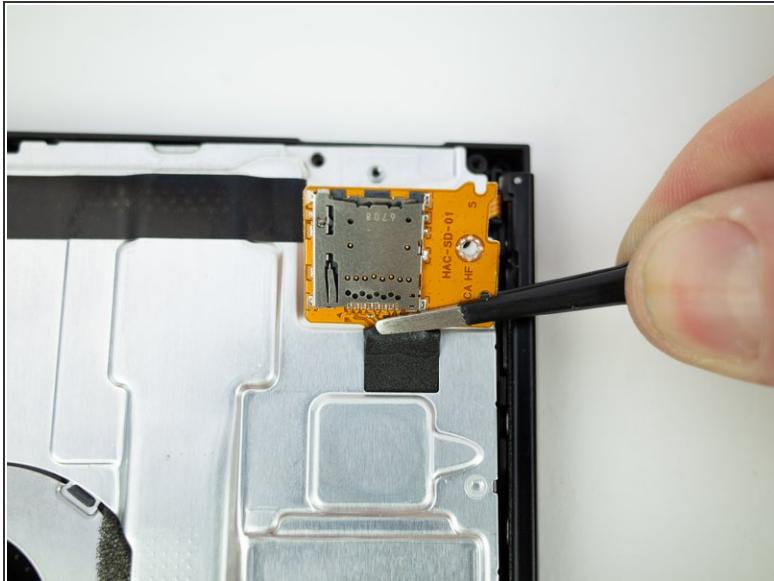
- Pull the rear panel up and off of the device.

Step 7 — Micro SD Card Reader



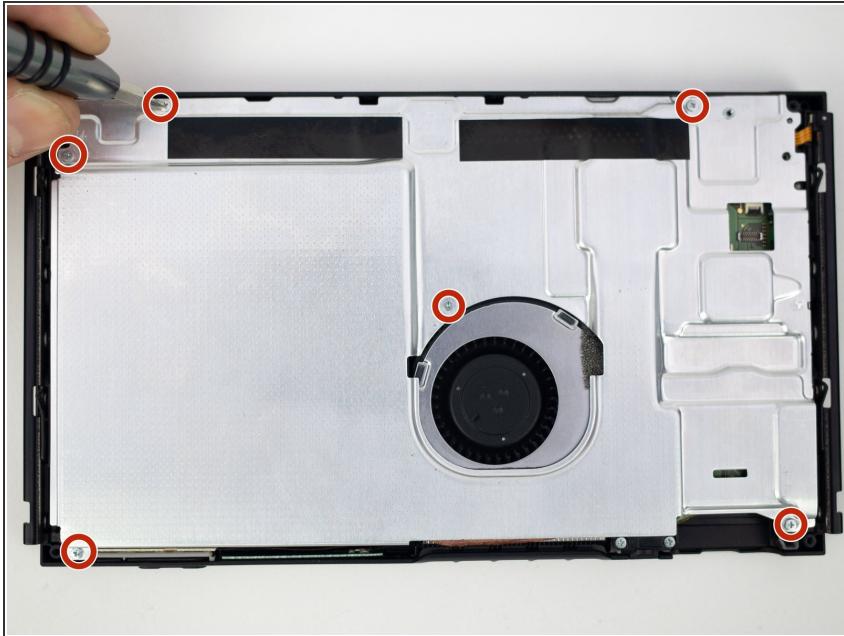
- Remove the single 3.1 mm Phillips screw from micro SD card board.

Step 8



- Gently lift the micro SD card board straight up, away from the Switch to disconnect and remove it.
- During reassembly, line up the micro SD card board and lightly press on the foam pad until the press connector snaps into place to reconnect it.

Step 9 — Shield Plate



- Remove the six 3.1mm Phillips #000 screws from the shield plate.

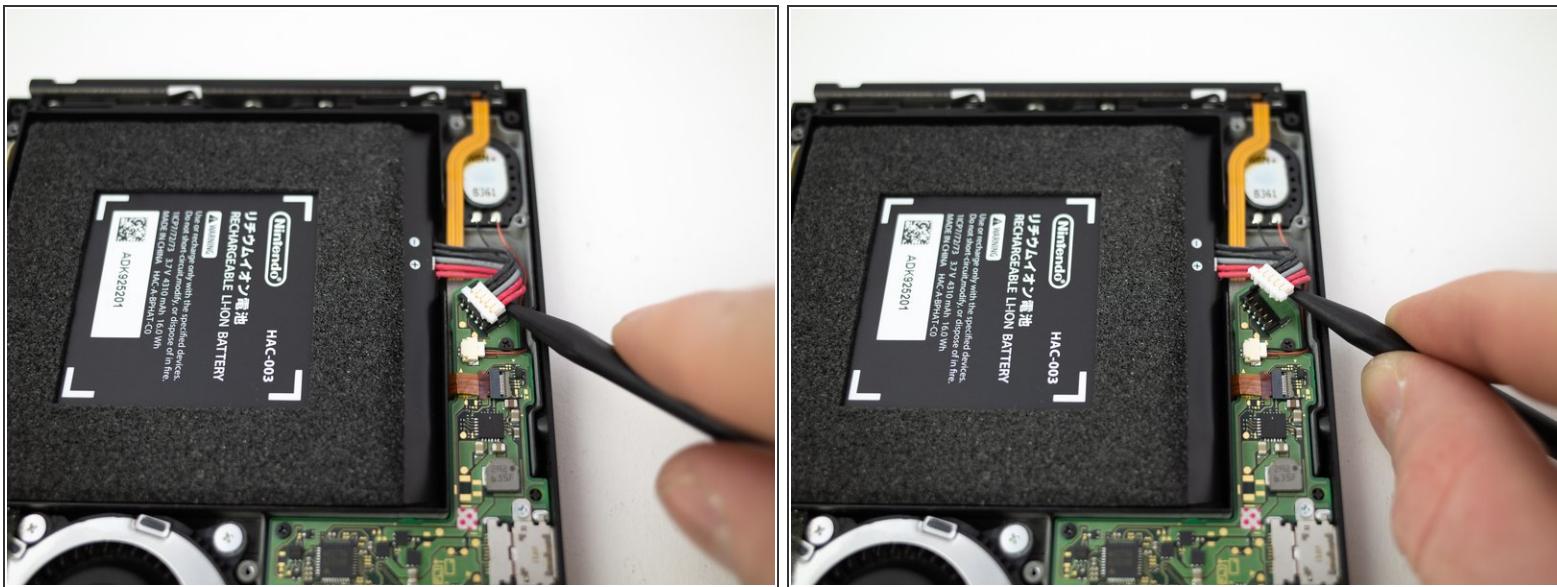
Step 10



- Remove the shield plate from the device.

★ A thick pink thermal compound bridges the gap between the shield plate and the copper heat sink underneath. For best results, whenever the shield plate is removed, refer to our [thermal paste guide](#) to remove the old thermal compound and replace it with an appropriate, thick compound such as [K5 Pro](#) during reassembly.

Step 11 — Battery Disconnect



- Insert the pointed end of a spudger underneath the white connector and pry upwards to disconnect the battery from the motherboard.

Step 12 — Heat Sink



- Remove the three 3.1mm Phillips #000 screws from the heatsink.

Step 13

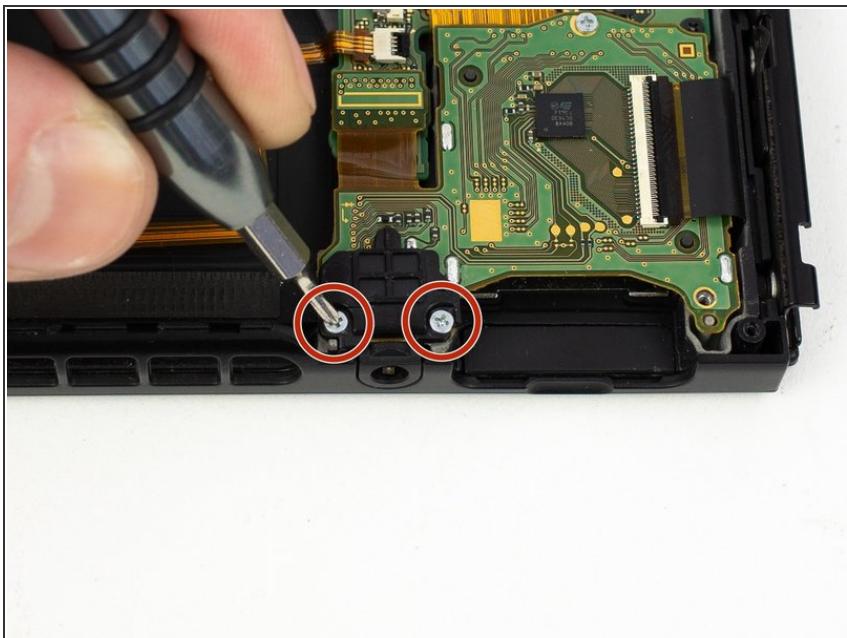


- Pull the heatsink up 45 degrees and rotate it to the right to remove.

★ Before reassembly, follow the [thermal paste guide](#).

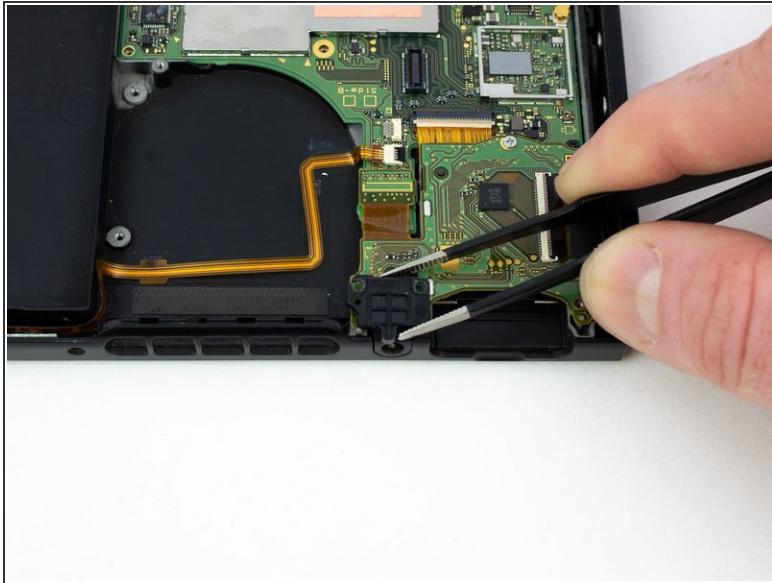
- Clean all the thermal paste off the underside of the heat sink using isopropyl alcohol (>90%) or Artic Silver ArctiClean.
- Clean and **replace** the thermal paste on the processor cover.

Step 14 — Headphone Jack and Game Card Board



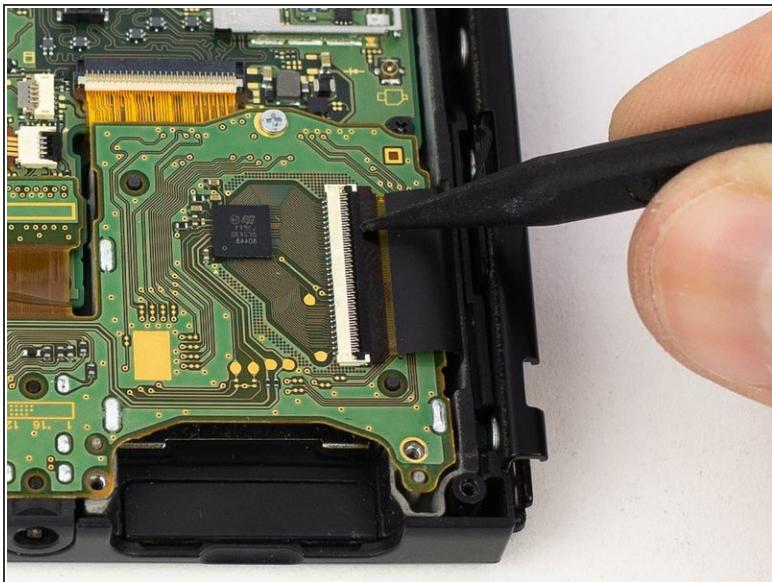
- Remove the two 3.1 mm Phillips screws from the headphone jack bracket.

Step 15



- Remove the headphone jack bracket.

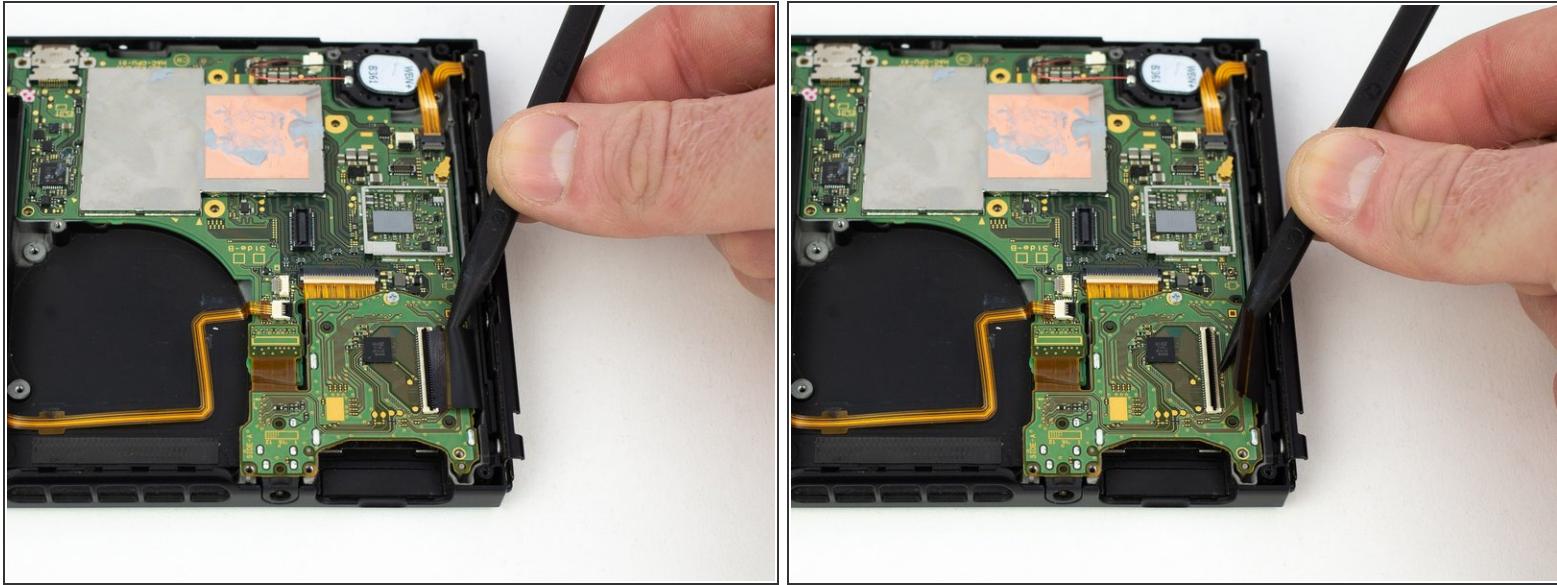
Step 16



- Use a spudger to lift the black locking flap on the ZIF connector up.

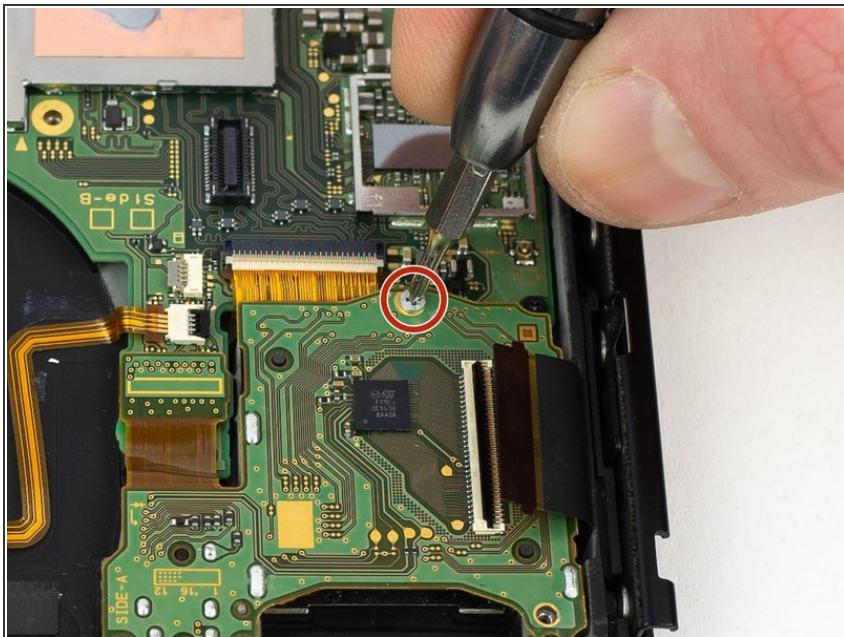
 To reconnect [ZIF connectors](#) like this one, gently slide the cable back in place and press the locking flap back into place.

Step 17



- Use the pointed end of a spudger to slide the ribbon cable out of the ZIF connector.

Step 18



- Remove the single 3.1 mm Phillips screw from the headphone jack and game card board.

Step 19



- Use the flat end of a spudger to pry the headphone jack press-fit connector straight up off the motherboard.

Step 20



- Remove the headphone jack and game card board.

To reassemble your device, follow these instructions in reverse order.